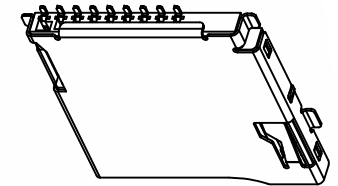
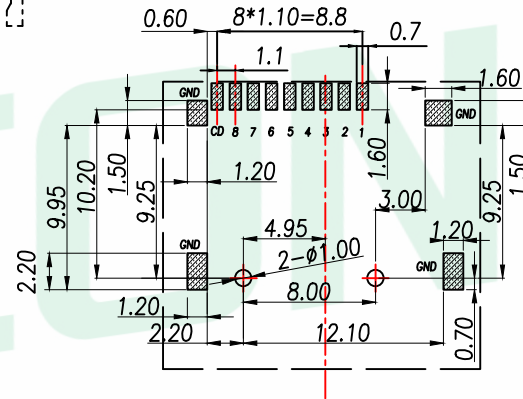
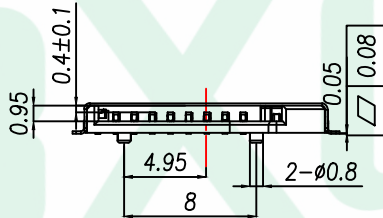
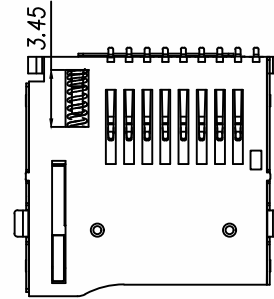
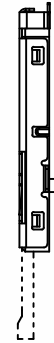
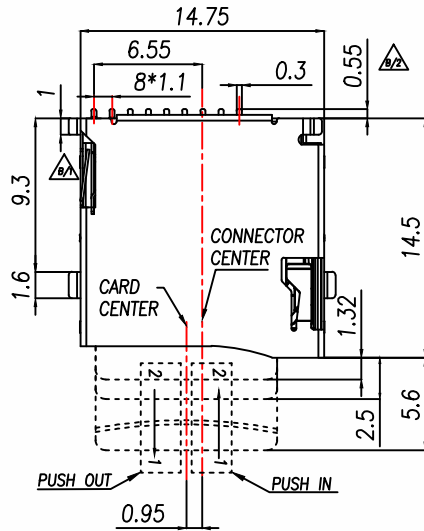
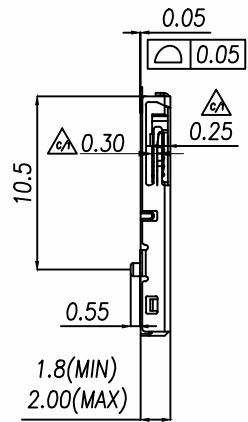


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REV.	DESCRIPTION	ECN NO.	NAME	DATE

Specification:

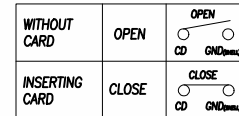
1. Electrical Characteristics:
 - Contact Current Rating: 0.5 Amperes.
 - Dielectric Withstanding Voltage: AC500V r.m.s.
 - Insulation Resistance: 1000 MΩ Minimum.
 - Contact Resistance: 40 mΩ Maximum.
2. Environmental:
 - Operating Temperature: -25°C ~ +90°C.
3. Environmental:
 - Mating Cycles: 5,000 Insertions.
4. Mechanical Characteristics:
 - Card Push Insertion/Out Force: 0.2 ~ 1.40kgf.
 - Contact Separation Force: 0.20kgf Minimum.
5. Material:
 - Insulator: HI-Temp Plastic UL 94V-0 Rated.
 - Contact: Copper Alloy (t=0.15mm).
 - Shell: Stainless Steel (t=0.15mm).
 - Spring: SWP.



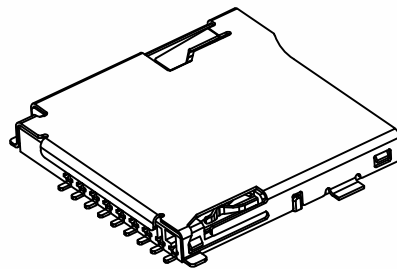
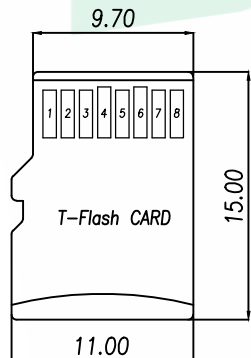
TF CARD PIN DEFINE			
PIN NO.	NAME	TYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

▨ PAD AREA
 ■ KEEP OUT AREA

Circuit Diagram for Detect Switch



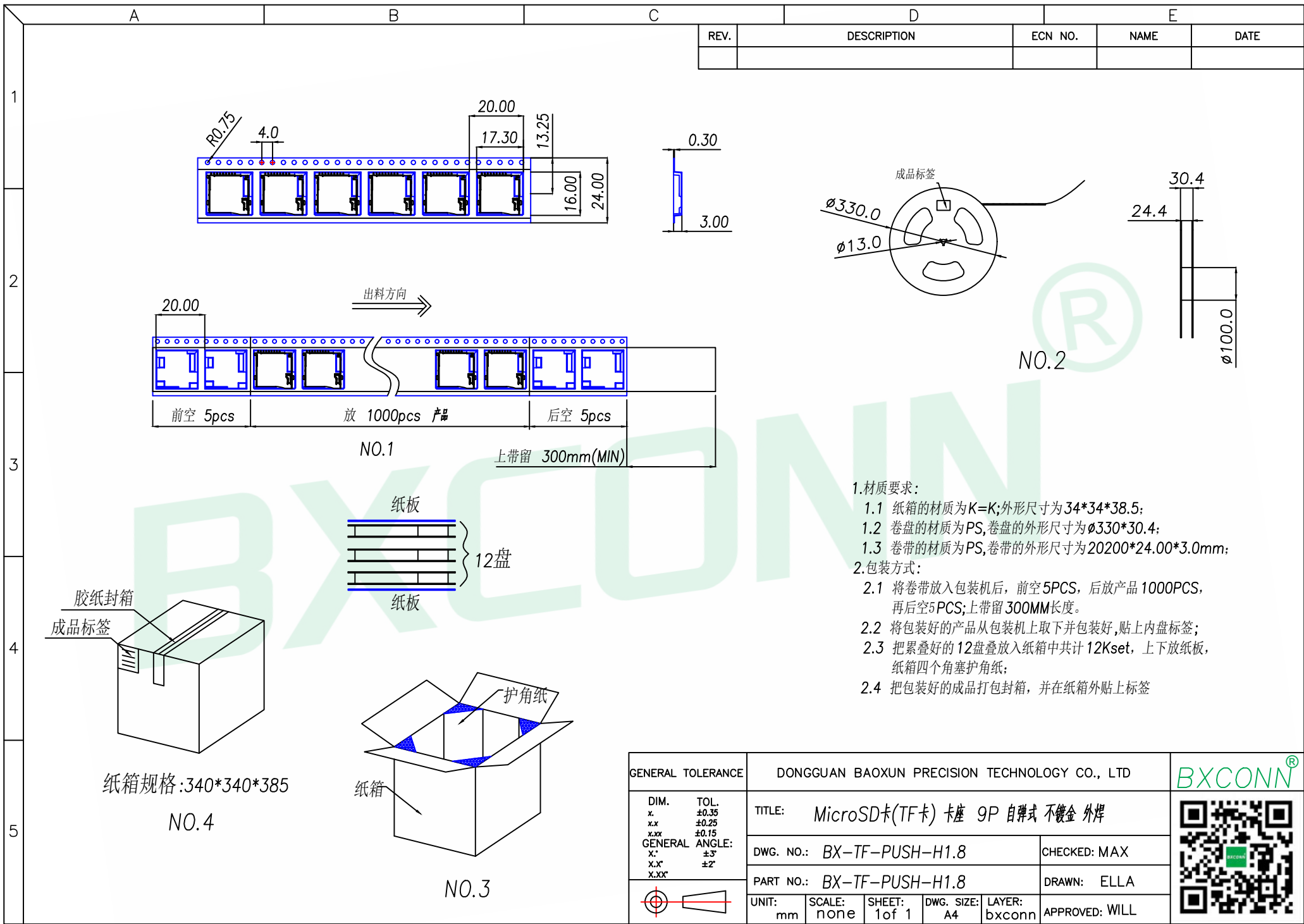
RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05



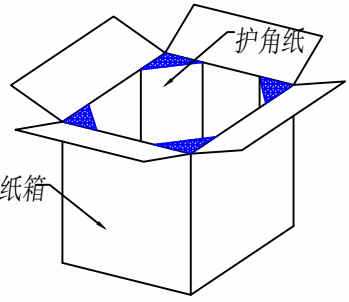
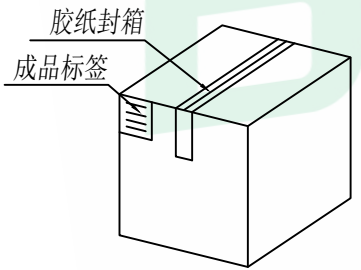
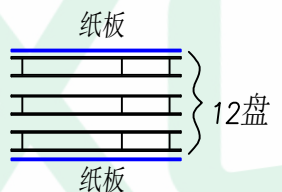
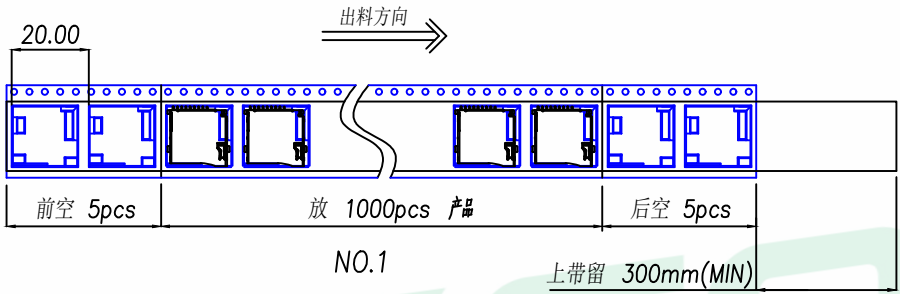
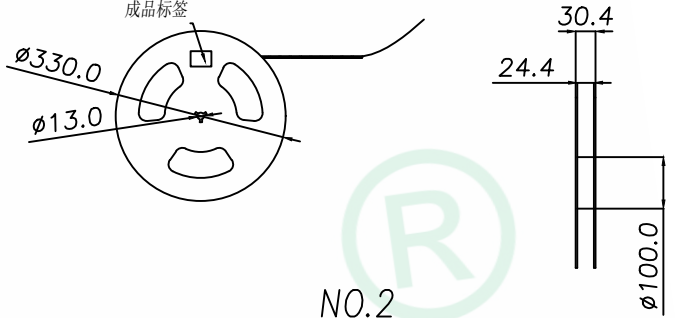
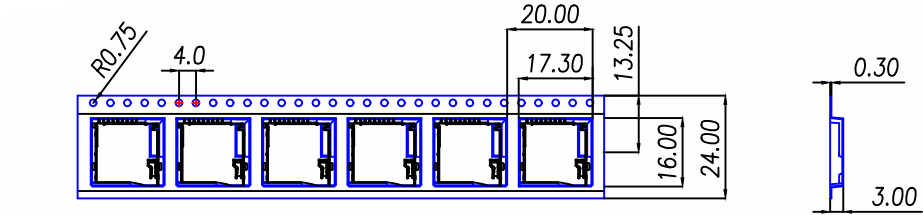
GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD	
DIM. TOL.	TITLE: MicroSD卡(TF卡) 卡座 9P 自弹式 不镀金 外焊	
x. ±0.35	DWG. NO.: BX-TF-PUSH-H1.8	CHECKED: MAX
x.x ±0.25	PART NO.: BX-TF-PUSH-H1.8	DRAWN: ELLA
x.xx ±0.15	UNIT: mm	APPROVED: WILL
GENERAL ANGLE:	SCALE: none	SHEET: 1 of 1
x.° ±3°	DWG. SIZE: A4	LAYER: bxconn
x.x° ±2°		

BXCONN®





REV.	DESCRIPTION	ECN NO.	NAME	DATE



1. 材质要求:
- 1.1 纸箱的材质为K=K;外形尺寸为34*34*38.5;
 - 1.2 卷盘的材质为PS,卷盘的外形尺寸为 $\phi 330*30.4$;
 - 1.3 卷带的材质为PS,卷带的外形尺寸为20200*24.00*3.0mm;
2. 包装方式:
- 2.1 将卷带放入包装机后,前空5PCS,后放产品1000PCS,再后空5PCS;上带留300MM长度。
 - 2.2 将包装好的产品从包装机上取下并包装好,贴上内盘标签;
 - 2.3 把累叠好的12盘放入纸箱中共计12Kset,上下放纸板,纸箱四个角塞护角纸;
 - 2.4 把包装好的成品打包封箱,并在纸箱外贴上标签

GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD				
DIM.	TOL.	TITLE: MicroSD卡(TF卡) 卡座 9P 自弹式 不镀金 外焊				
x.	±0.35	DWG. NO.: BX-TF-PUSH-H1.8		CHECKED: MAX		
x.x	±0.25	PART NO.: BX-TF-PUSH-H1.8		DRAWN: ELLA		
x.xx	±0.15	UNIT: mm		SCALE: none	SHEET: 1 of 1	
GENERAL ANGLE:		DWG. SIZE: A4		LAYER: bxconn		
x.°	±3°	APPROVED: WILL				
x.x°	±2°					